## 504077149 11/01/2016

# **PATENT ASSIGNMENT COVER SHEET**

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
YING-NAN WEN	12/25/2015
CHIEN-HUNG LIU	12/25/2015
SHIH-YI LEE	12/25/2015
HO-YIN YIU	12/25/2015

### **RECEIVING PARTY DATA**

Name:	XINTEC INC.
Street Address:	9F., NO. 23, JILIN RD.
Internal Address:	ZHONGLI DIST.
City:	TAOYUAN CITY
State/Country:	TAIWAN
Postal Code:	320

## **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	15340909	

#### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER: WEN LIU

SIGNATURE: /Wen Liu, Reg. No. 32,822/

DATE SIGNED: 11/01/2016

**Total Attachments: 2** 

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# ASSIGNMENT

is assignment agreement is applicable to an invention entitled (invention Title)				
CHIP PACKAGE AND FABRICATION METHOD THEREOF				
The PATENT RIGHTS referred to in this agreement are:				
(check one) Sa patent application for this invention, executed by the ASSIGNOR(S)				
concurrently with this assignment.				
U.S. patent application Serial Notiled				
a U.S. patent application based on PCT International Application				
Nofiled on (date)(U.S. patent application				
Serial No, if known),				
U.S. patent No, issued				
The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of				
the patents and patent applications identified above.				
The PATENT RIGHTS assigned under this agreement are:				
(check one) U.S. patent rights only.				
Worldwide patent rights. In this case, the assignee shall have the right to				
claim the benefit of the filing date of any U.S. or foreign patent application				
for this invention.				
The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures				
appear on page 2 of this Assignment and any Supplemental Sheet(s).				
The ASSIGNEE referred to in this agreement is:				
(Name of Assignee) Xintec Inc.				
(Address) 9F., No.23, Jilin Rd., Zhongli Dist., Taoyuan City 320, Taiwan, R.O.C.				
The ASSIGNEE is:				
(check one)[]An individual.				
A Partnership.				
(other)				
The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and				
valuable consideration, receipt of which is acknowledged, hereby assign(s) the following				
rights to the ASSIGNEE, its successors and assigns:				
the full and exclusive right to the invention;				
the entire right, title and interest in and to the PATENT RIGHTS;				
the right to sue and recover for any past infringement; and				
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable				
provisions, based on any earlier patent applications for this invention.				

PATENT REEL: 040191 FRAME: 0139 THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO ASSIGNEE: Xinted Inc.
INVENTION TITLE:

## CHIP PACKAGE AND FABRICATION METHOD THEREOF

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Ying-Nan WEN	jy-Na We	2015/12/25
Name of sole or first inventor	Signature	Date
Chien-Hung LIU	Chien Hung (21) Signature	2015/12/25
Name of second inventor, if any	Signature /	Date
Shih-Yi LEE	Shih-Yi Lee	2015/12/25
Name of third inventor, if any	Signature	Date
Ho-Yin YIU	47lle	2015/12/25
Name of fourth inventor, if any	Signature	Date

PATENT REEL: 040191 FRAME: 0140

**RECORDED: 11/01/2016**